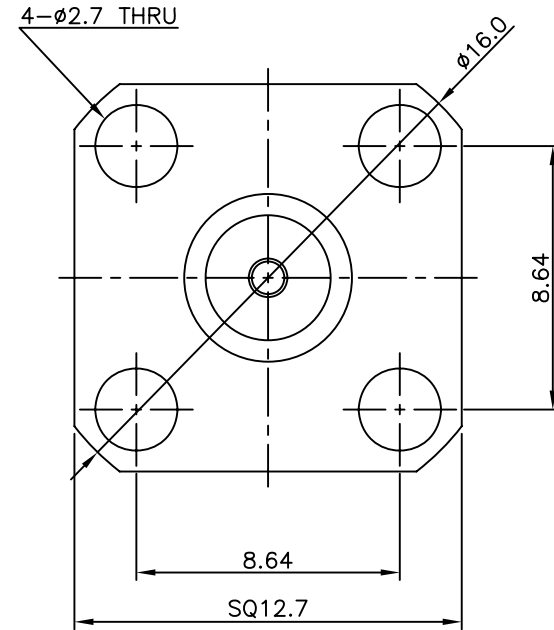
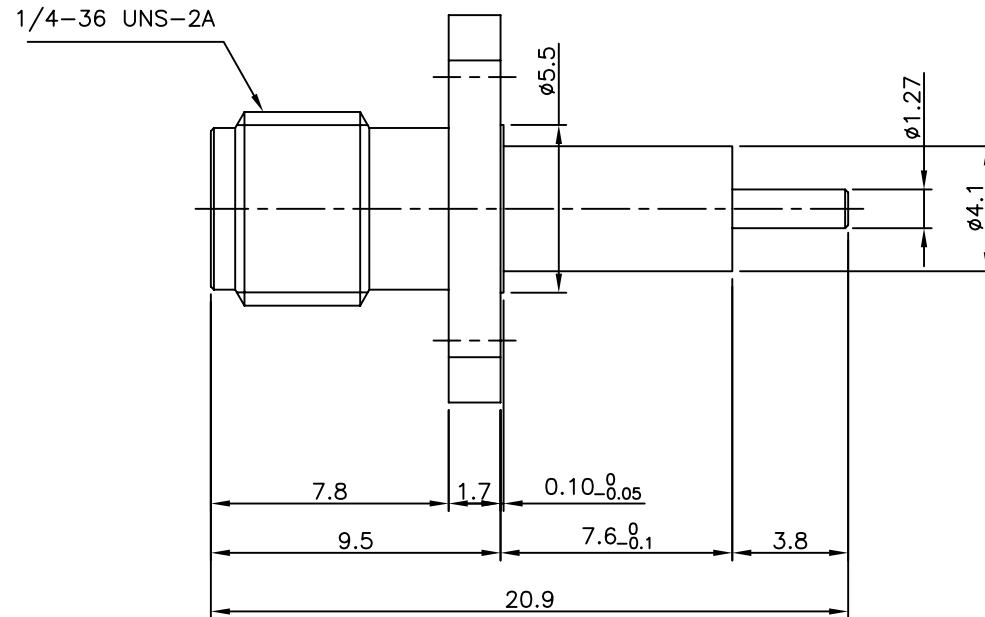


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2021.05.07.
1	[설번No.202105-0013]완제품 공차 관리로 인한 절연체 전장길이 공차 변경	S.Y.EUN	I.C.KIM	2021.05.25.



3	INSULATOR	1	TEFLON		DIN01500-N/2 DIN01500-N/1
2	CONTACT	1	BeCu C17300	Gold Plate (1.27μm)	DCT04211-5/2
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04725-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2021. 05. 25.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	-	CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JS-4H
		DRAWN BY	S.Y.EUN	
FINISH	-	SCALE	4/1	A4 DWG NO. CN03987-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	